

STN	Polovodičové súčiastky Časť 16-6: Mikrovlnné integrované obvody Frekvenčné multiplikátory	STN EN IEC 60747-16-6 35 8797
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Semiconductor devices - Part 16-6: Microwave integrated circuits - Frequency multipliers

Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 12/19

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August 2019

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**Semiconductor devices - Part 16-6: Microwave integrated
circuits - Frequency multipliers
(IEC 60747-16-6:2019)**

Dispositifs à semiconducteurs - Partie 16-6: Circuits
intégrés hyperfréquences - Multiplicateurs de fréquence
(IEC 60747-16-6:2019)

Halbleiterbauelemente - Teil 16-6: Integrierte
Mikrowellenschaltkreise - Frequenzvervielfachung
(IEC 60747-16-6:2019)

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EN IEC 60747-16-6:2019 (E)**European foreword**

The text of document 47E/602/CDV, future edition 1 of IEC 60747-16-6, prepared by SC 47E "Discrete semiconductor devices" of IEC/TC 47 "Semiconductor devices" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 60747-16-6:2019.

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Annex ZA (normative)

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NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60617	-	Graphical symbols for diagrams	-	-
IEC 60747-1	2006	Semiconductor devices - Part 1: General	-	-
+ A1	2010		-	-
IEC 60747-4	-	Semiconductor devices - Discrete devices - - Part 4: Microwave diodes and transistors		-
IEC 60747-16-3	2002	Semiconductor devices - Part 16-3: EN 60747-16-3 Microwave integrated circuits - Frequency converters		2002
+ A1	2009		+ A1	2009
+ A2	2017		+ A2	2017
IEC 61340-5-1	-	Electrostatics - Part 5-1: Protection of electronic devices from electrostatic phenomena - General requirements	EN 61340-5-1	-
IEC/TR 61340-5-2	-	Electrostatics -- Part 5-2: Protection of electronic devices from electrostatic phenomena - User guide	CLC/TR 61340-5-2-	



IEC 60747-16-6

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INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Semiconductor devices –
Part 16-6: Microwave integrated circuits – Frequency multipliers**

**Dispositifs à semiconducteurs –
Partie 16-6: Circuits intégrés hyperfréquences – Multiplicateurs de fréquence**





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IEC 60747-16-6

Edition 1.0 2019-06

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Semiconductor devices –
Part 16-6: Microwave integrated circuits – Frequency multipliers**

**Dispositifs à semiconducteurs –
Partie 16-6: Circuits intégrés hyperfréquences – Multiplicateurs de fréquence**

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

SEMICONDUCTOR DEVICES –**Part 16-6: Microwave integrated circuits –
Frequency multipliers**

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International Standard IEC 60747-16-6 has been prepared by subcommittee 47E: Discrete semiconductor devices, of IEC technical committee 47: Semiconductor devices.

The text of this International Standard is based on the following documents:

CDV	Report on voting
47E/602/CDV	47E/622A/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

The French version of this standard has not been voted upon.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 60747 series, published under the general title *Semiconductor devices*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
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SEMICONDUCTOR DEVICES –

Part 16-6: Microwave integrated circuits – Frequency multipliers

1 Scope

This part of IEC 60747 specifies the terminology, essential ratings and characteristics, and measuring methods of microwave integrated circuit frequency multipliers.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60617, *Graphical symbols for diagrams* (available at <http://std.iec.ch/iec60617>)

IEC 60747-1:2006, *Semiconductor devices – Part 1: General*
IEC 60747-1:2006/AMD 1:2010

IEC 60747-4, *Semiconductor devices – Discrete devices – Part 4: Microwave diodes and transistors*

IEC 60747-16-3:2002, *Semiconductor devices – Part 16-3: Microwave integrated circuits – Frequency converters*
IEC 60747-16-3:2002/AMD 1:2009
IEC 60747-16-3:2002/AMD 2:2017

IEC 61340-5-1, *Electrostatics – Part 5-1: Protection of electronic devices from electrostatic phenomena – General requirements*

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